



# DEPARTMENT OF COMPUTER SYSTEM ENGINEERING

Digital Integrated Circuits - ENCS333

**Dr. Khader Mohammad**  
**Lecture #5**

***Static CMOS Logic part 1***



# PROCESS FILE LINK:

- [https://github.com/siwS/vlsi/blob/master/vlsi\\_2011/MW3.1.7/MW3.1.7/rules/cmos65n.rul](https://github.com/siwS/vlsi/blob/master/vlsi_2011/MW3.1.7/MW3.1.7/rules/cmos65n.rul)
- <http://ptm.asu.edu/>
- [www.mosis.org](http://www.mosis.org)
-

# Agenda

- **General complementary logic design, perspective, stick-figure circuit diagrams**
- **Examples: constructing PDN/PUN duals,**  
**logic -> circuit, circuit -> logic,**  
**circuit -> layout, layout -> circuit,**  
**cross sectional views of layout**

# What is a MOSFET?

**A resistor:** 
$$R_n = \frac{1}{\mu_n C_{ox} (V_{GS} - V_{Tn})} \left( \frac{L}{W} \right)$$

- (among other things ...) Increasing  $W$  decreases the resistance; allows more current to flow

**Oxide capacitance**  $C_{ox} = \epsilon_{ox} / t_{ox}$  [F/cm<sup>2</sup>]

**Transconductance**  $\beta_n = \mu_n C_{ox} \left( \frac{W}{L} \right) = k'_n \left( \frac{W}{L} \right)$

**Gate capacitance**  $C_G = C_{ox} WL$  [F]

# nFET vs. pFET

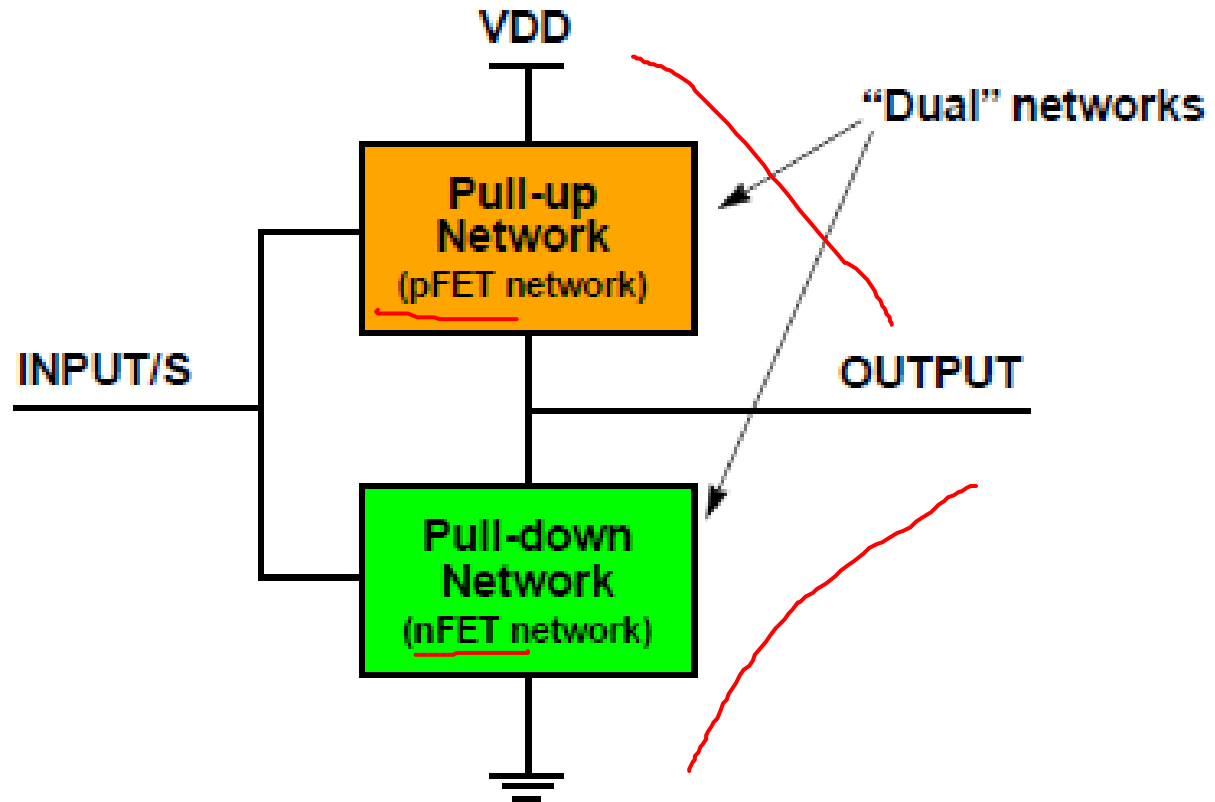
$$R_n = \frac{1}{\beta_n (V_{DD} - V_{Tn})} \quad \beta_n = \mu_n C_{ox} \left( \frac{W}{L} \right)_n$$
$$R_p = \frac{1}{\beta_p (V_{DD} - |V_{Tp}|)} \quad \beta_p = \mu_p C_{ox} \left( \frac{W}{L} \right)_p$$

$$\frac{\mu_n}{\mu_p} = r \quad \text{Typically} \\ (2 \dots 3)$$

( $\mu$  is the carrier mobility through device)

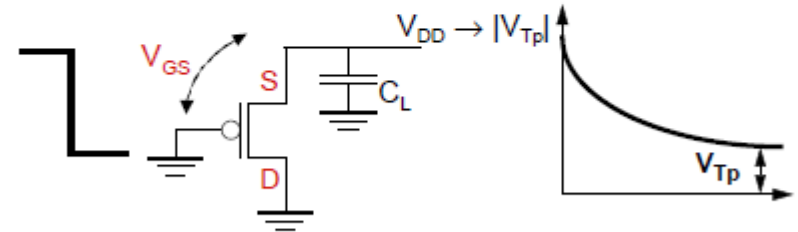
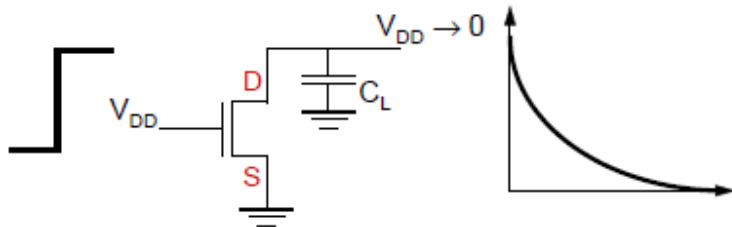
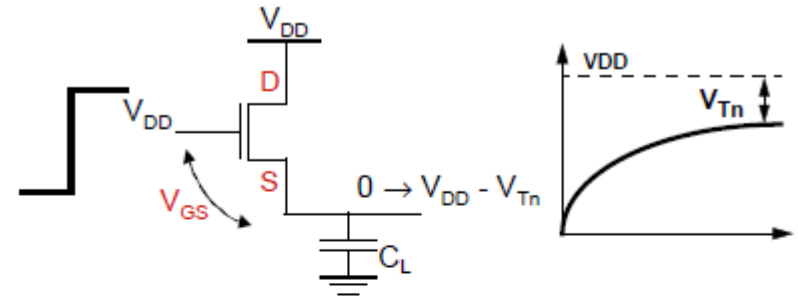
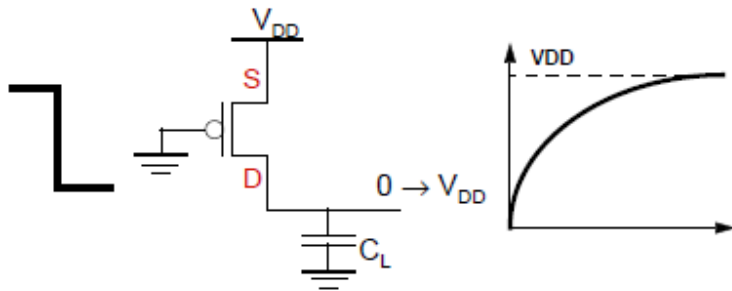
(We will return to this later ...)

# Complementary Design



- PMOS "Pull-Up" Network (PUN)
- NMOS "Pull-Down" Network (PDN)

# Why Division?

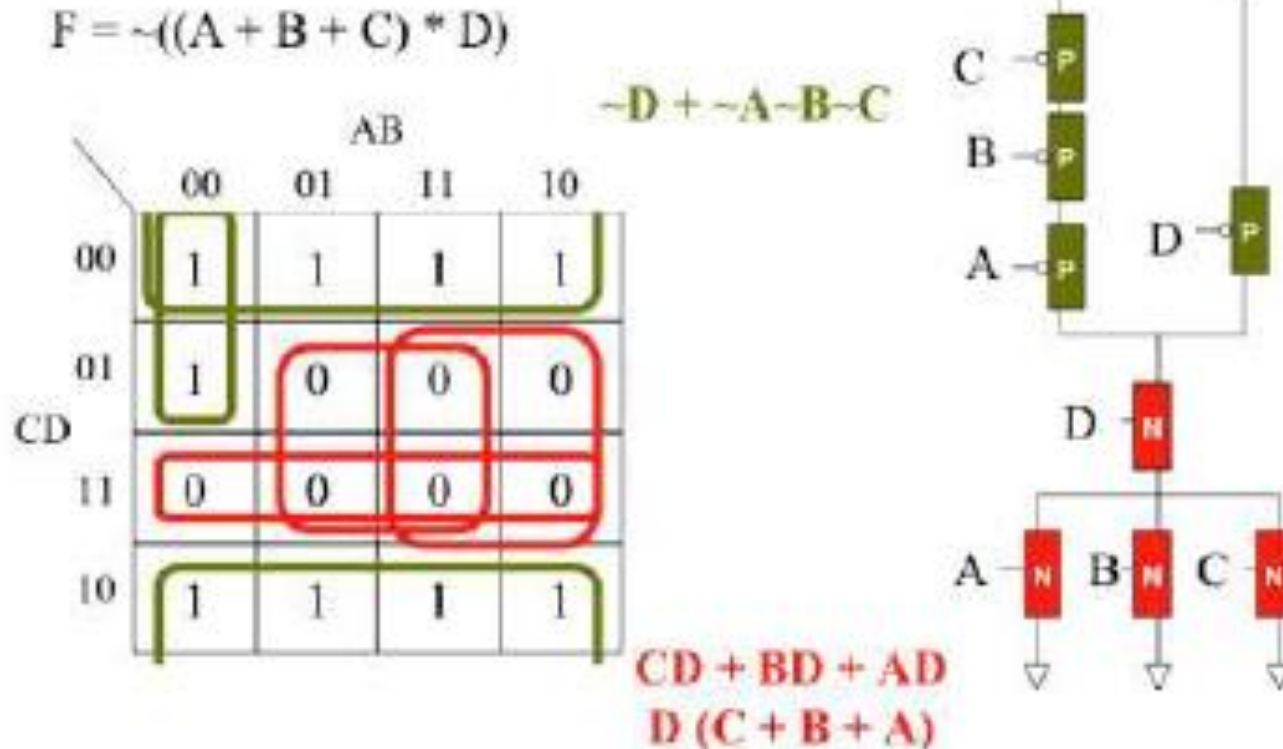


PMOS will pass a "1"  
NMOS will pass a "0"

NMOS will not pass a "1"  
PMOS will not pass a "0"



# Implements Arbitrary Logic



- **Pull-Up Network:** on when function = 1
- **Pull-Down Network:** on when function = 0

# Static CMOS: Perspective

- “Static” as in “output is logic function of inputs, and, given stable inputs, does not change over time”
- Propagation delay function of load capacitance and resistance of transistors

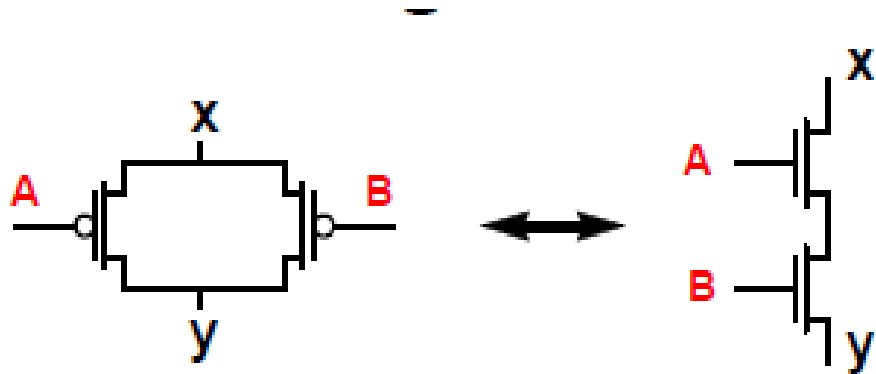
## PROS:

- Full rail-to-rail swing; **high noise margins**
- Logic levels not dependent upon relative device sizes
- Always a path to Vdd or Gnd in steady state; low **output impedance**
- Extremely high input resistance; **nearly zero steady-state input current**
- No direct path steady state between power and ground; **no static power dissipation**

## CONS:

- N inputs => **2N transistors in design**

# Constructing the Dual

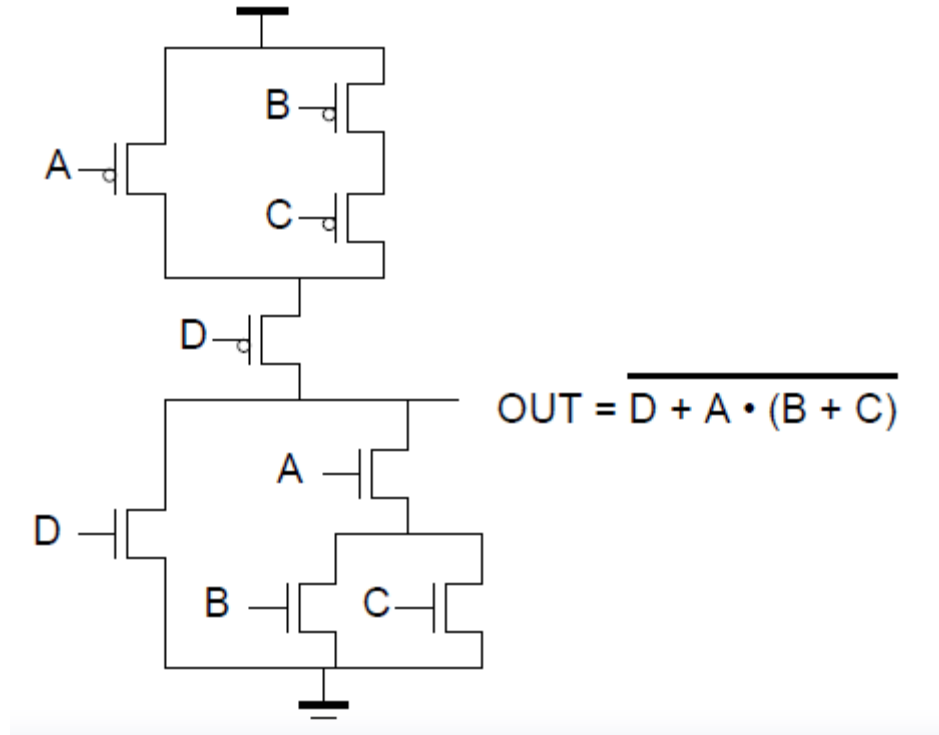


**Transistors in parallel are in series in dual;  
transistors in series are in parallel in dual**

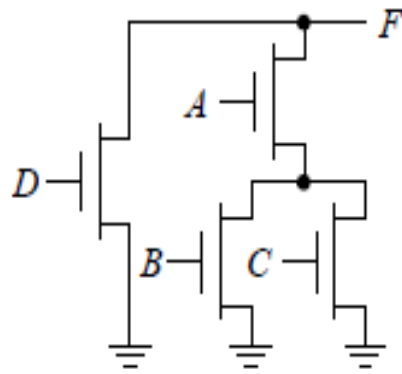
**This is the physical realization of DeMorgan's theorems:**

- $A + B = A \cdot B$  [ $!(A + B) = !A \cdot !B$  or  $!(A | B) = !A \& !B$ ]
- $A \cdot B = A + B$  [ $!(A \cdot B) = !A + !B$  or  $!(A \& B) = !A | !B$ ]

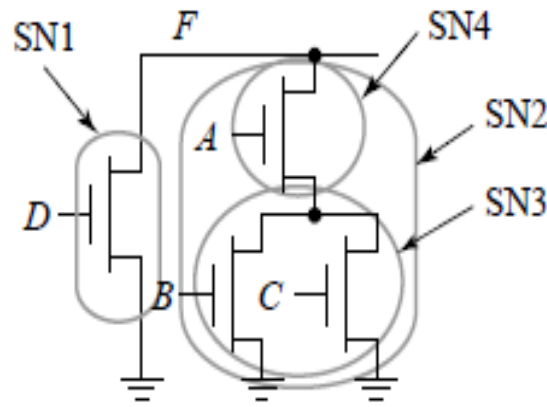
# Complex CMOS Gate



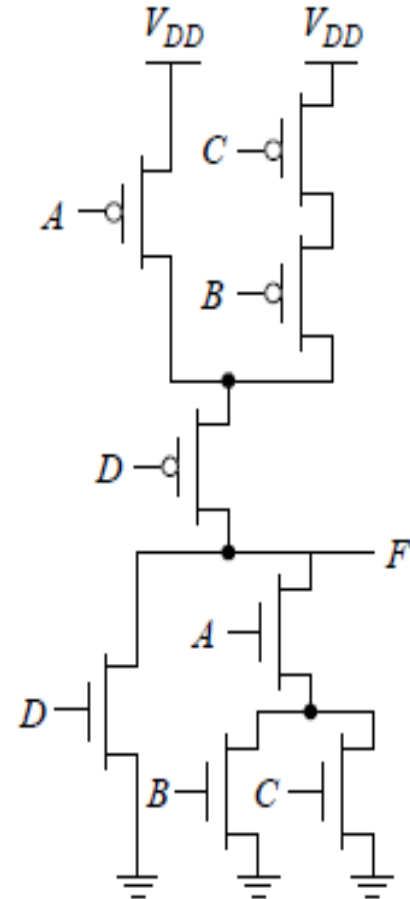
# Constructing a Complex Gate



(a) pull-down network



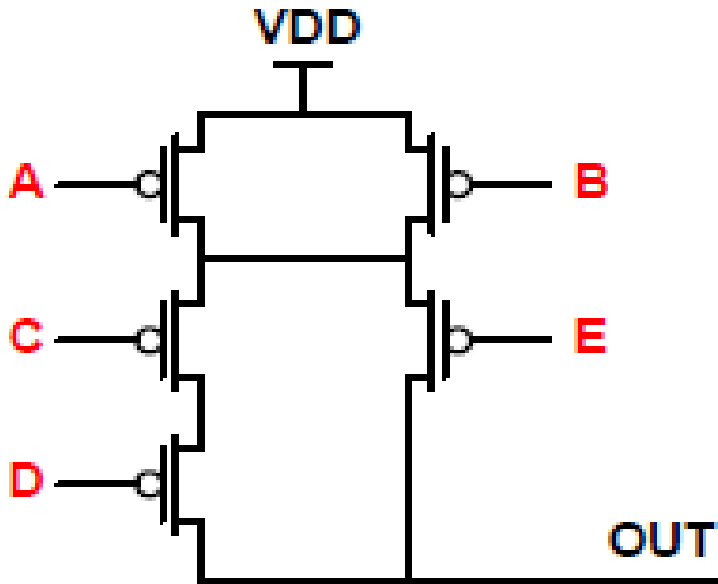
(b) Deriving the pull-up network hierarchically by identifying sub-nets



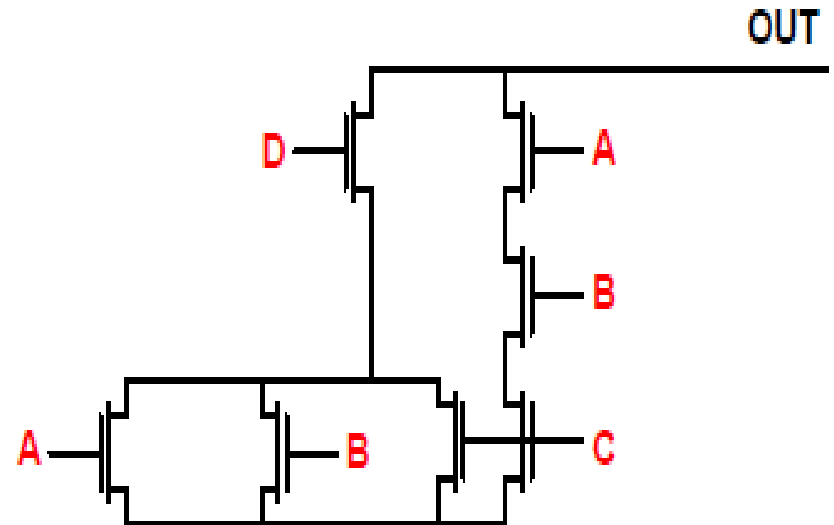
(c) complete gate

# Complex CMOS Gate

Constructing the Dual

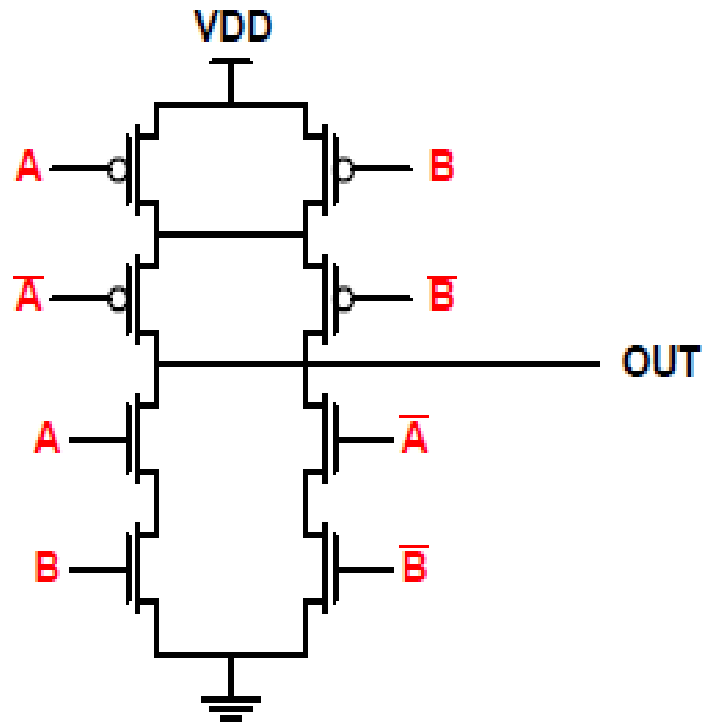


Constructing the Dual



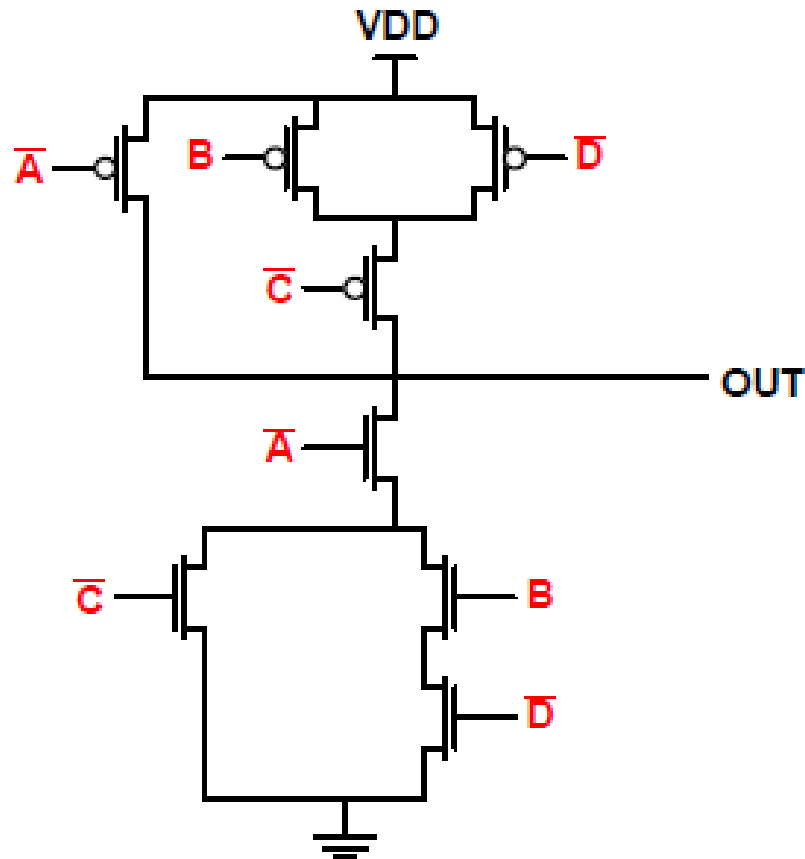
# Examples: Logic $\leftrightarrow$ Circuit

$$\text{XOR [ out = } \sim(\bar{A}\bar{B} + AB) \text{ ]}$$



# Examples: Logic $\leftrightarrow$ Circuit

$$\text{out} = \sim(\bar{A} \cdot (\bar{C} + B\bar{D}))$$

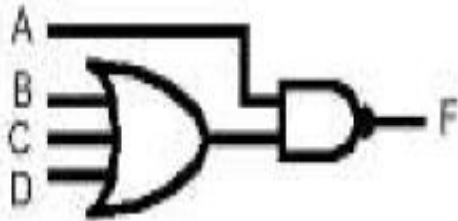




# Examples: Layout $\leftrightarrow$ Circuit

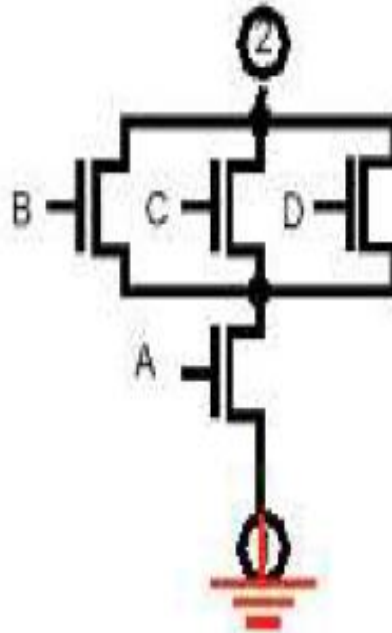
NOT ALL LAYOUTS ARE CREATED EQUAL

Let's look at two "equivalent" approaches

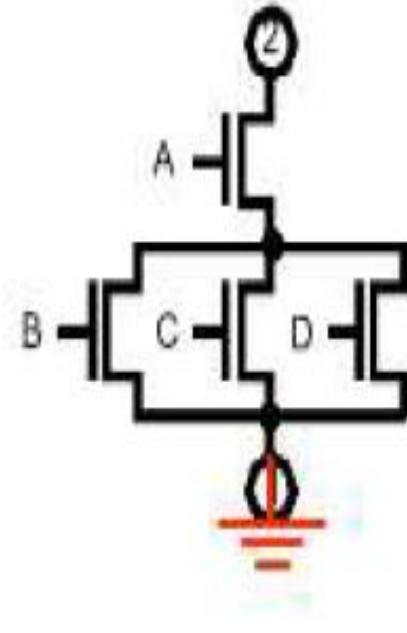


$$F = \text{NOT}(A(B+C+D))$$

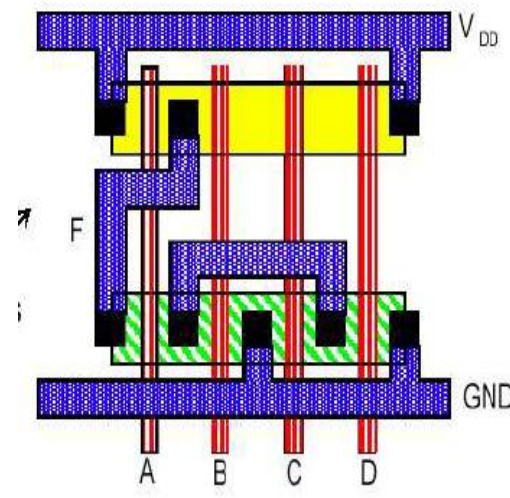
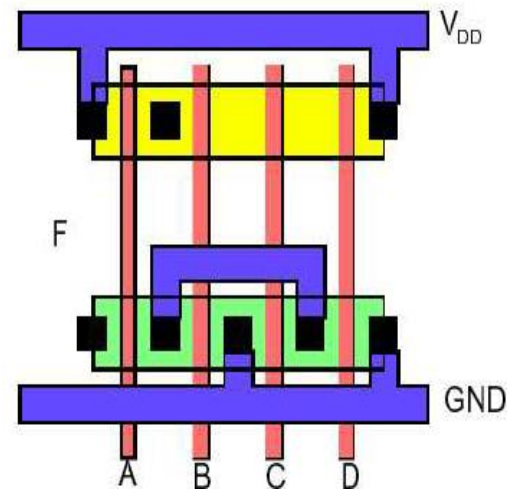
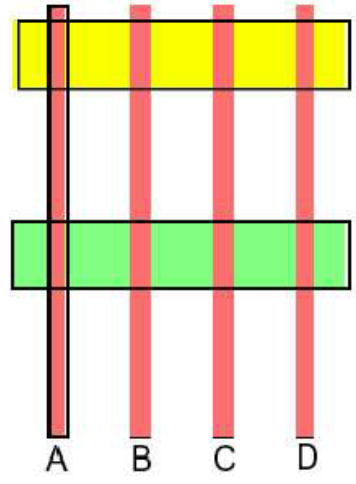
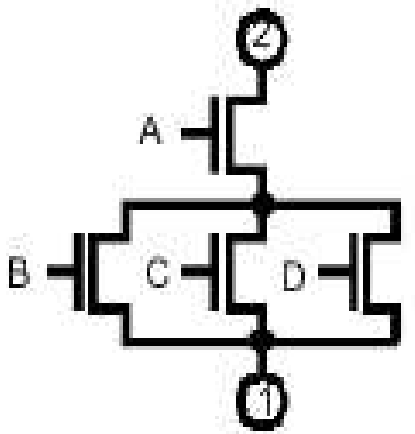
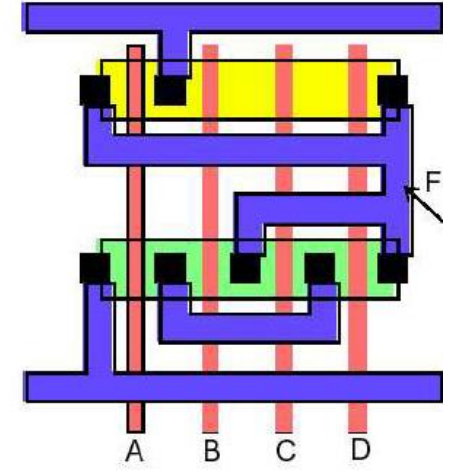
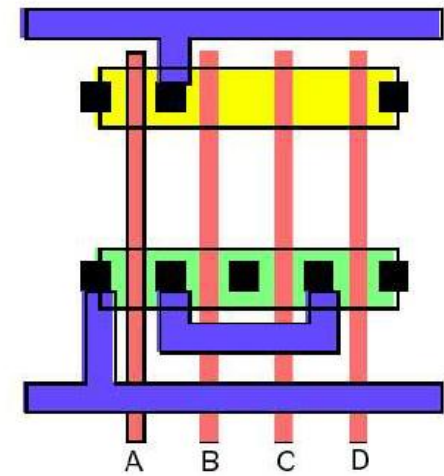
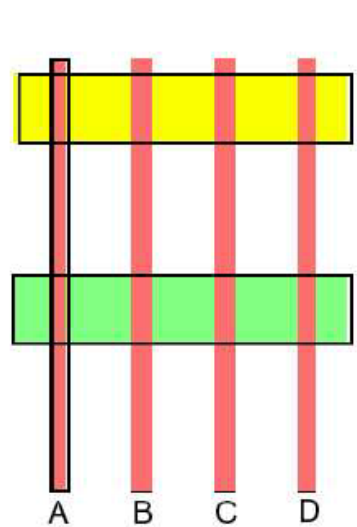
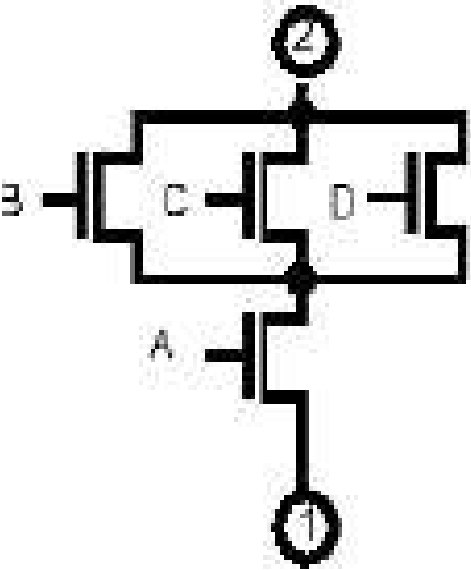
#1



#2

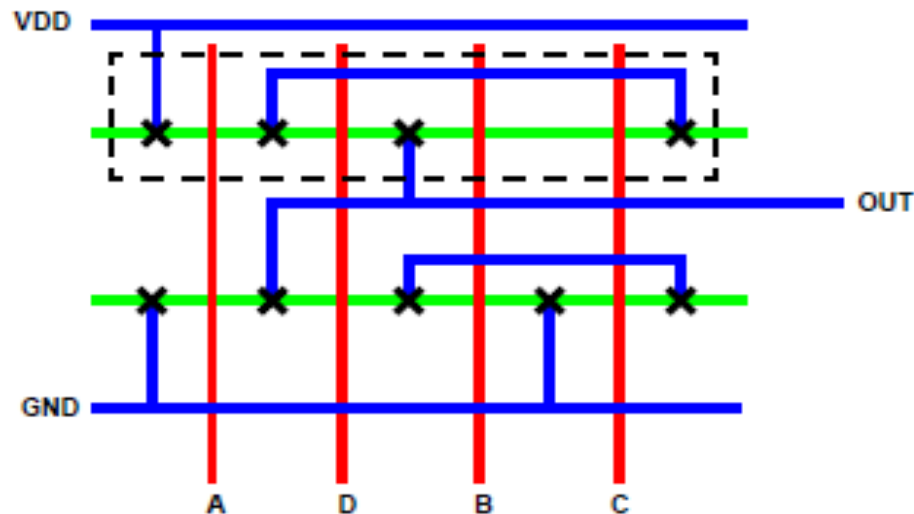
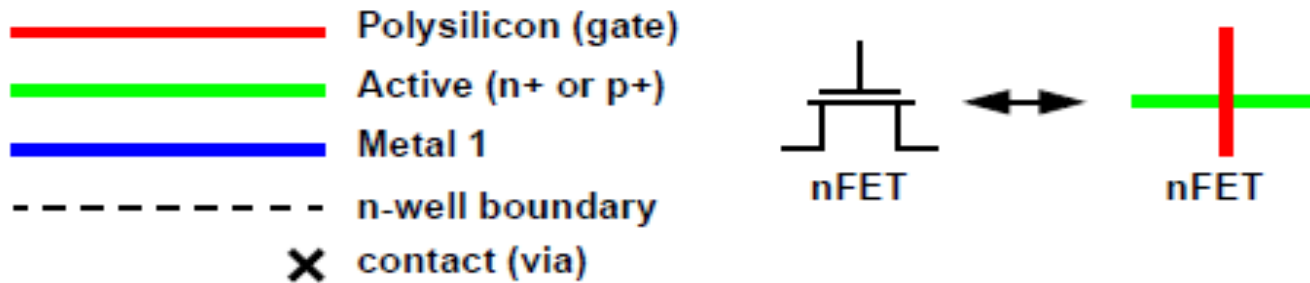


# Examples: Layout $\leftrightarrow$ Circuit



# Stick Diagrams

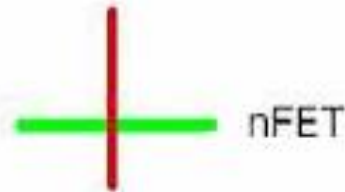
- Introduced by Mead & Conway in 80's
- Every line of conduction-material layer is represented by line of distinct color



# Stick Diagrams

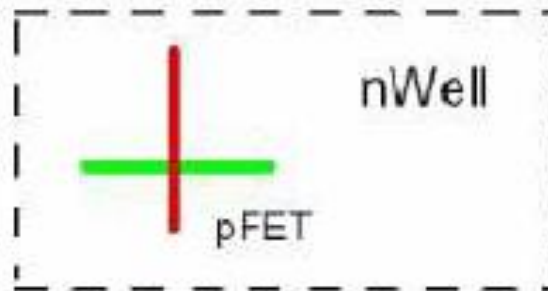
In terms of stick diagrams, we thus say that an nFET is formed whenever

Red (Poly) crosses over Green (Active)



This is consistent with a top view of the transistor.

A pFET is described by the same "red over green" coding, but the crossing point is contained within an nWell boundary

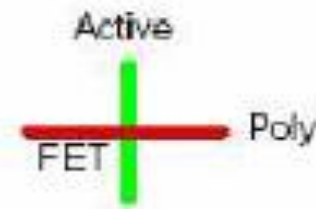


# Stick Diagrams

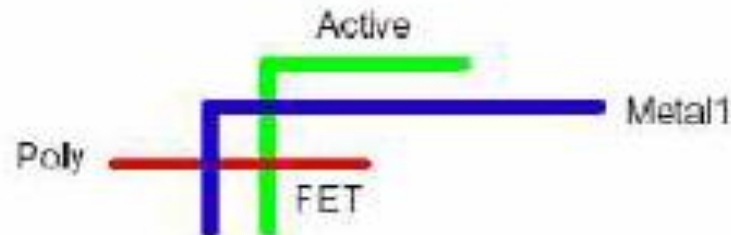
The rules for constructing stick diagrams are based on the characteristics of the conducting layers.

- Only the routing is important, not the line widths

- Red over green gives a FET  
(Poly) (Active)

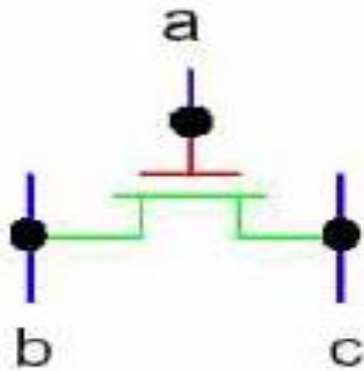


- Blue may cross over green or red without a connection  
(Metal1) (Active) (Poly)

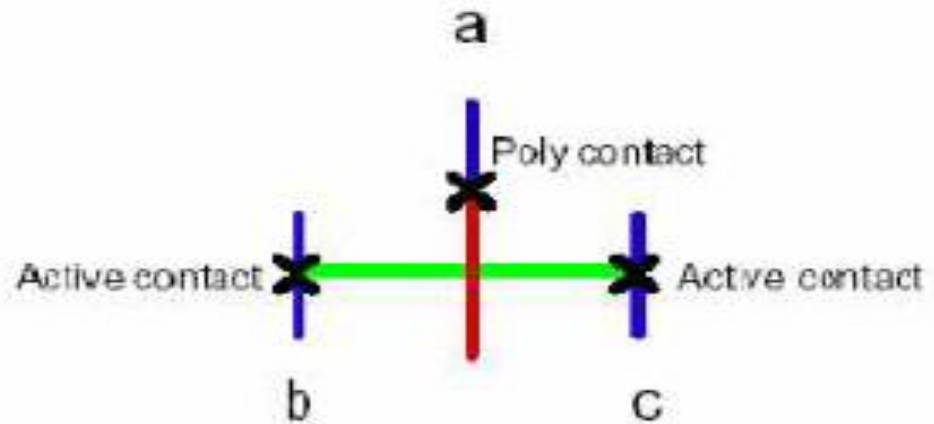


# Stick Diagrams

Connections between layers are specified by ✕



Schematic

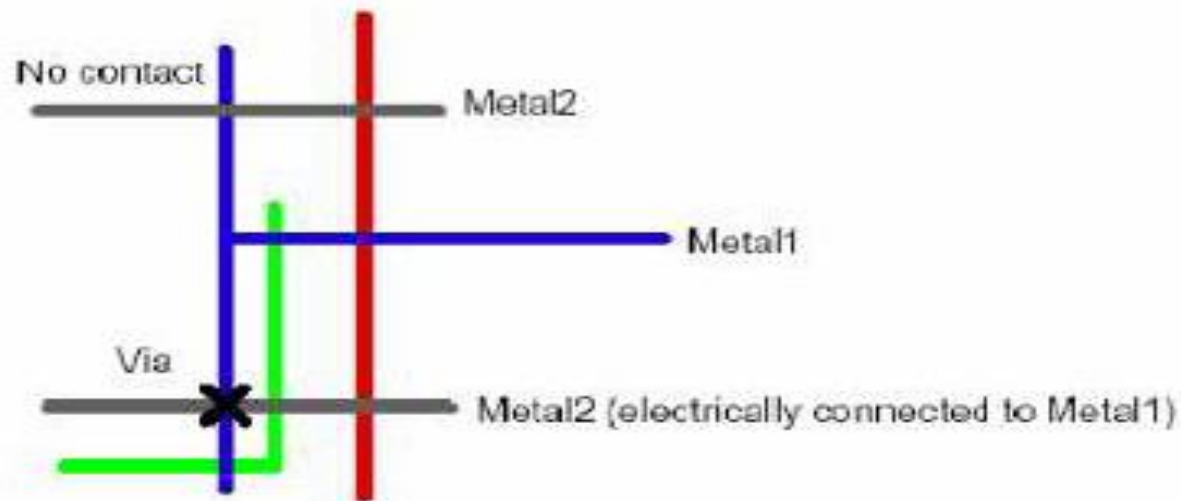


Stick diagram

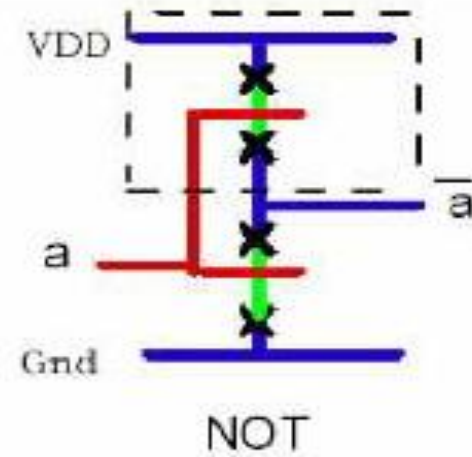
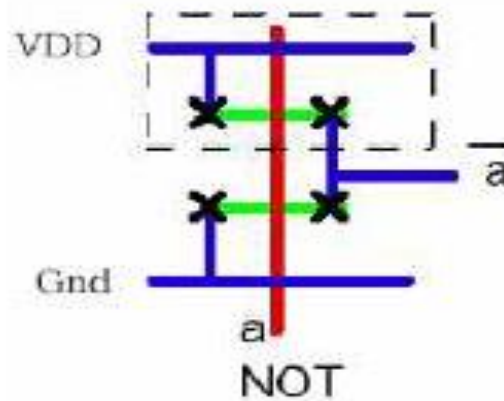
Poly contact: Metal1-to-Poly  
Active Contact: Metal1-to-Active

# Stick Diagrams

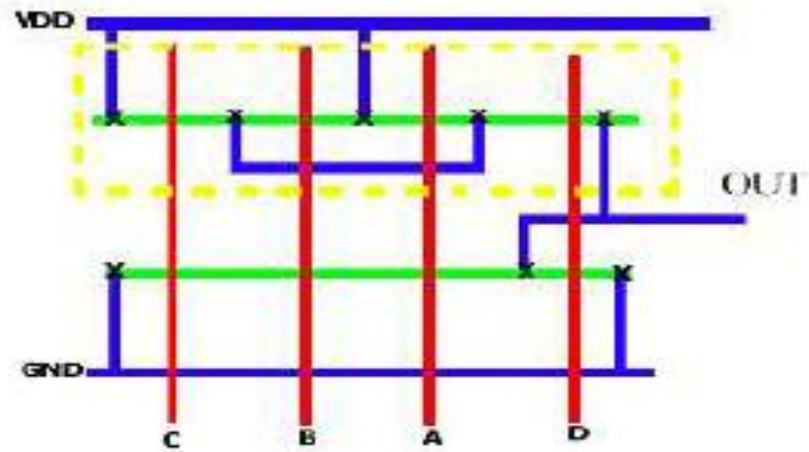
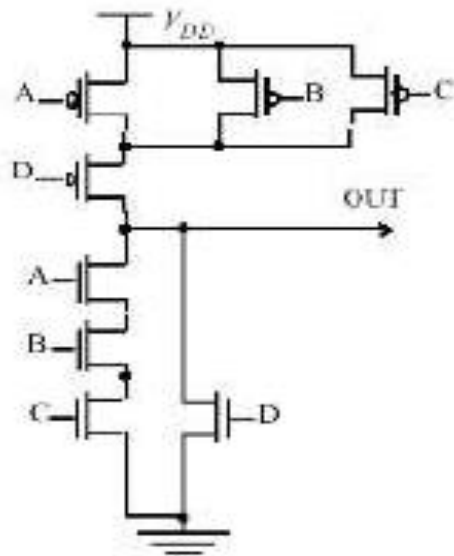
Metal lines on different layers can cross one another. Contacting two metal lines requires a via



# Stick Diagrams



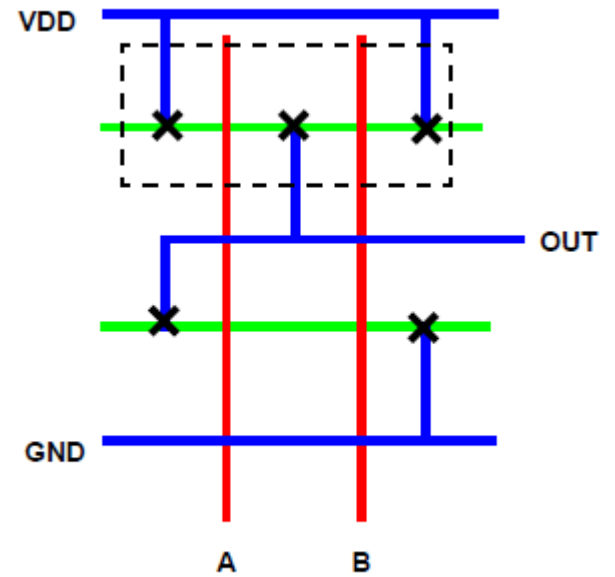
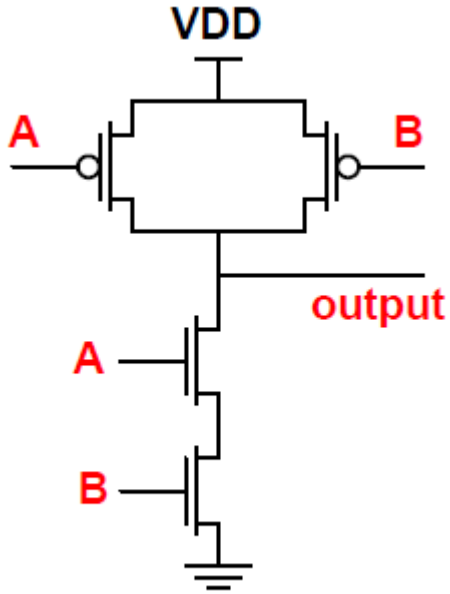
$$\text{OUT} = \overline{ABC + D}$$



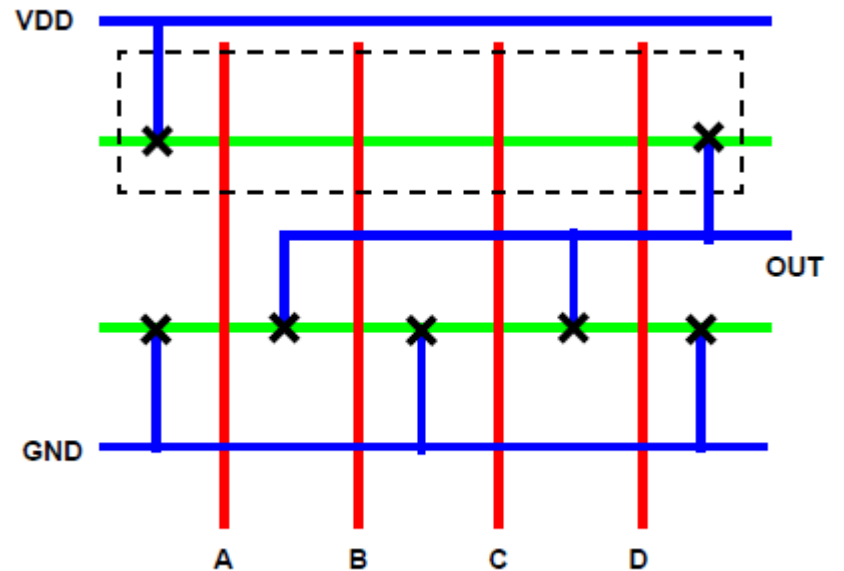
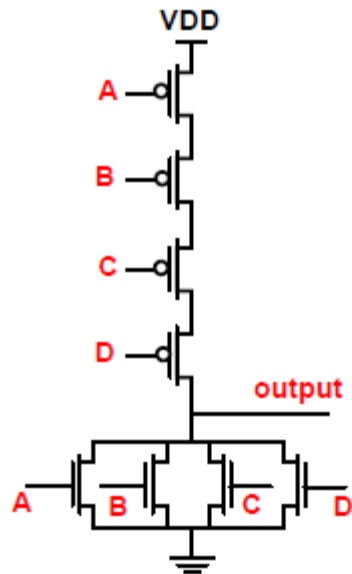


# Examples

## 2-input NAND

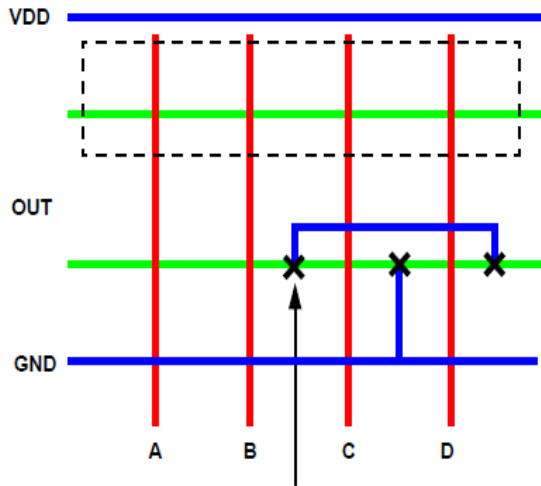
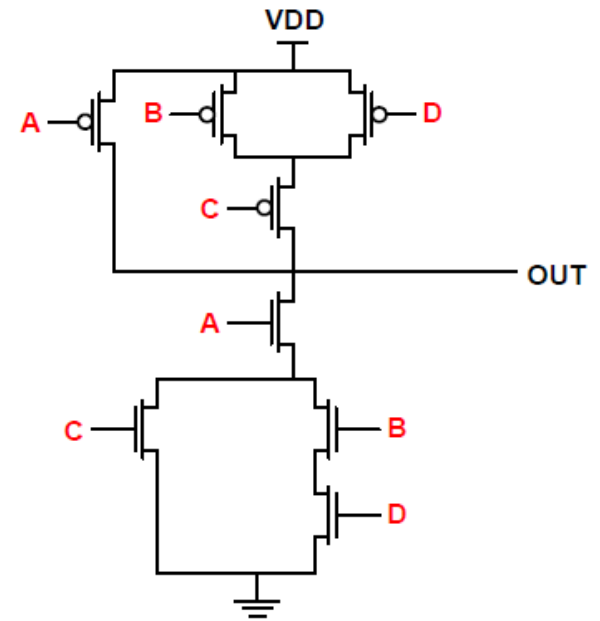


## 4-input NOR

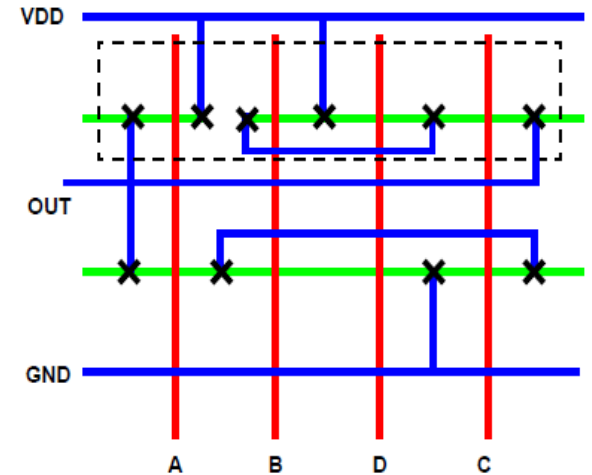
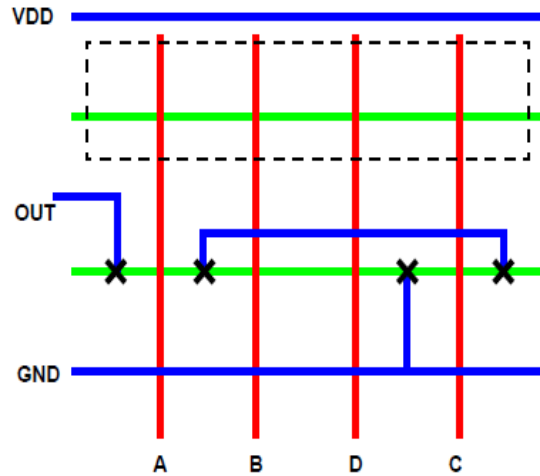


# Examples

$$\text{out} = \sim( A \cdot ( C + BD ) )$$



OOOPS -- can't do this



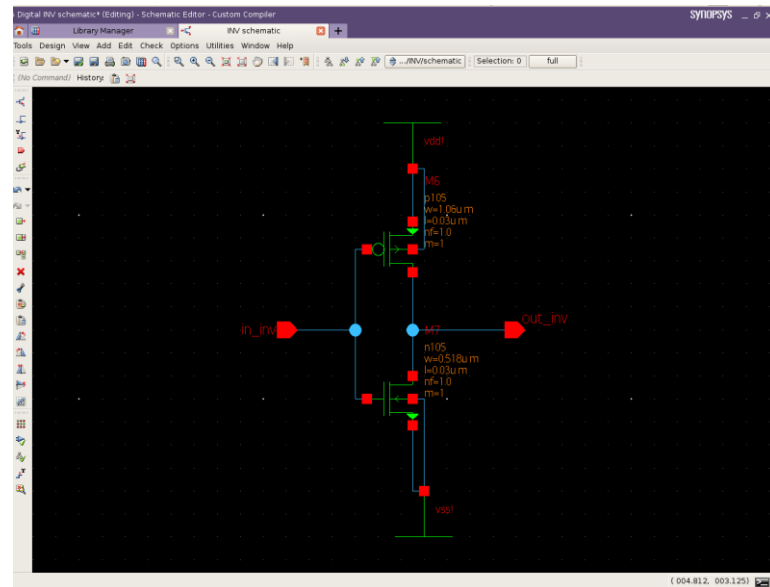
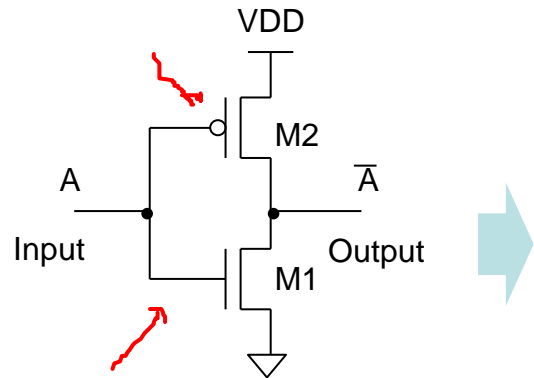
**For PUN, either re-route poly or cut p-diff**

# Schematic Design Goal

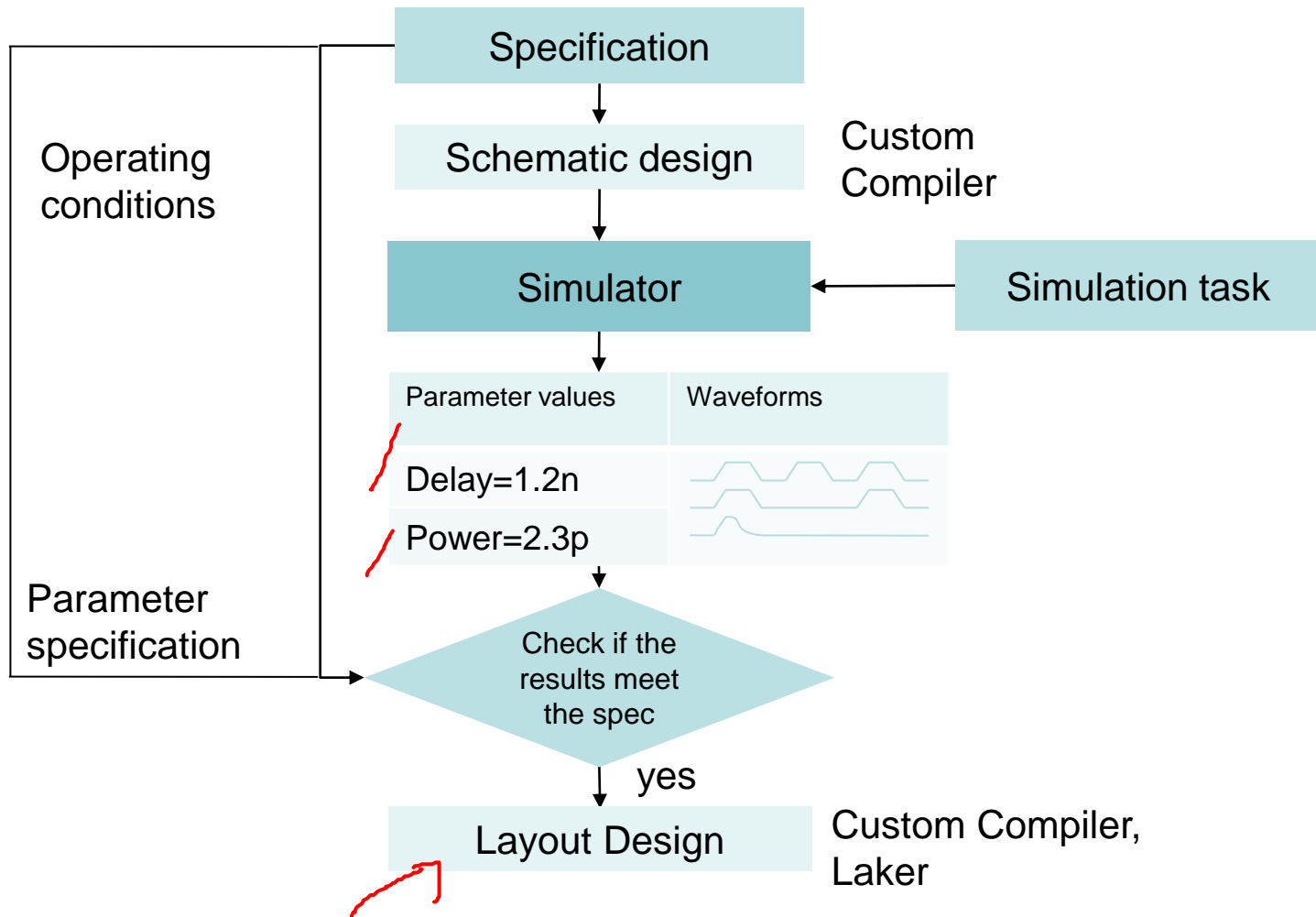
- The aim of schematic design is to create a circuit which works at operating conditions defined in specification and have the parameter values needed
- Schematic design
  - Structural synthesis
  - Parametric synthesis
  - Parametric optimization

# Circuit Selection

- Usually a known circuit structure is selected
- Design can find a convenient structure which is known to be good for the problem being solved

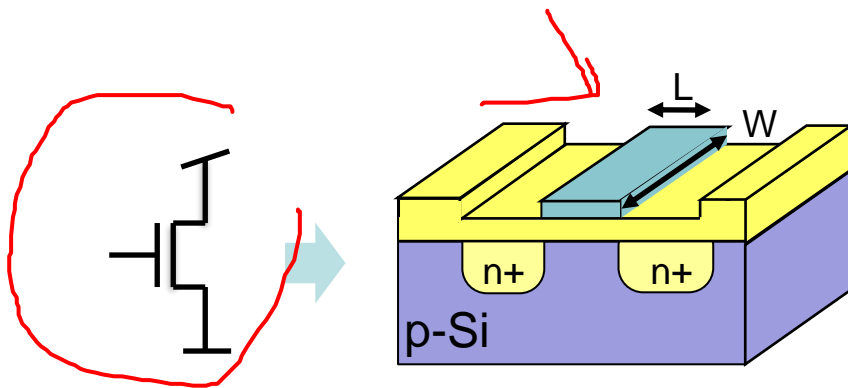


# Schematic Design

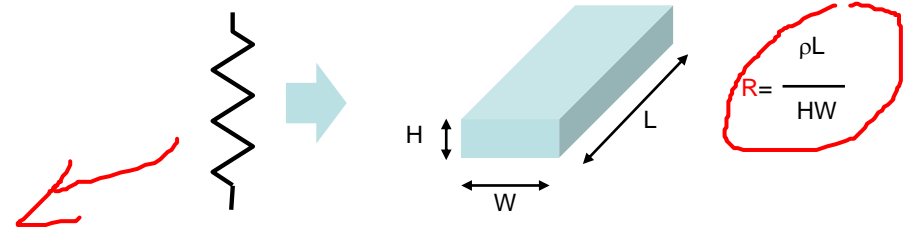


# Parametric Optimization

- Each device has configurable parameters
- Schematic designer changes these parameters to get a circuit which meets the specification



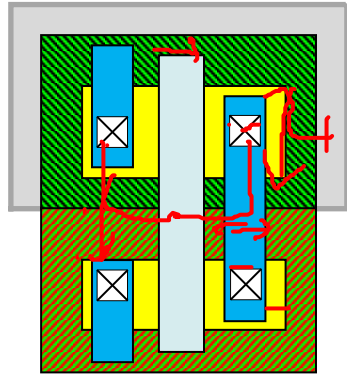
W - gate width, L - gate length



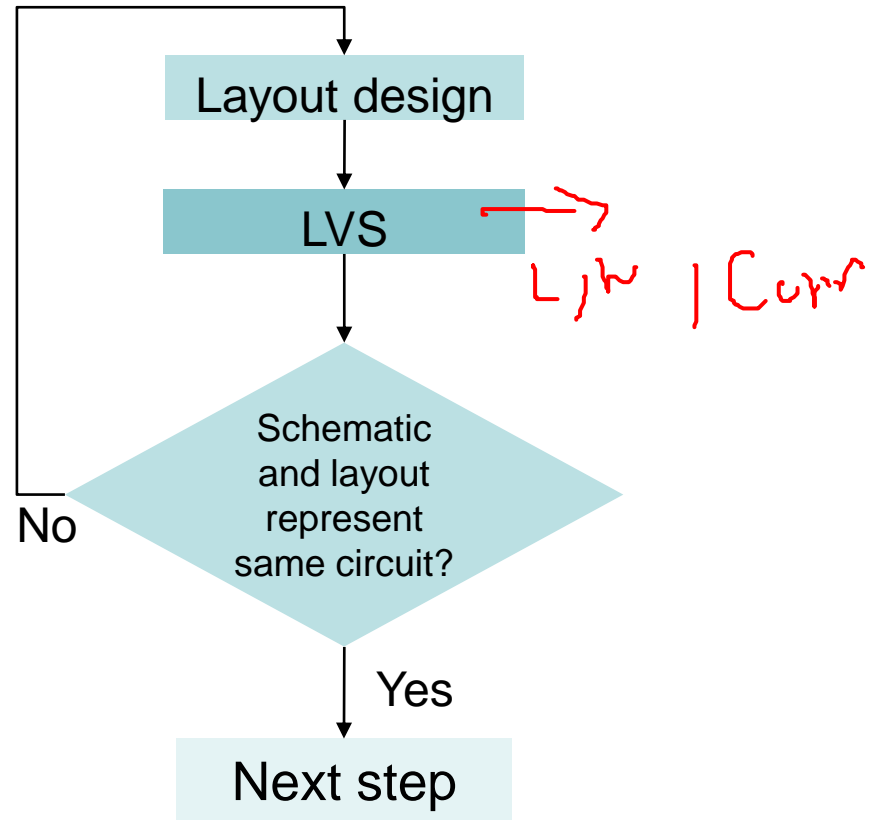
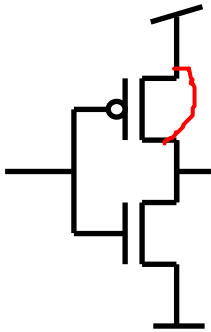
W - resistor width, L - resistor length

Transistor gate width and length, or resistor dimensions can be changed to change their electrical characteristics.

# Layout Versus Schematic (LVS)



DR



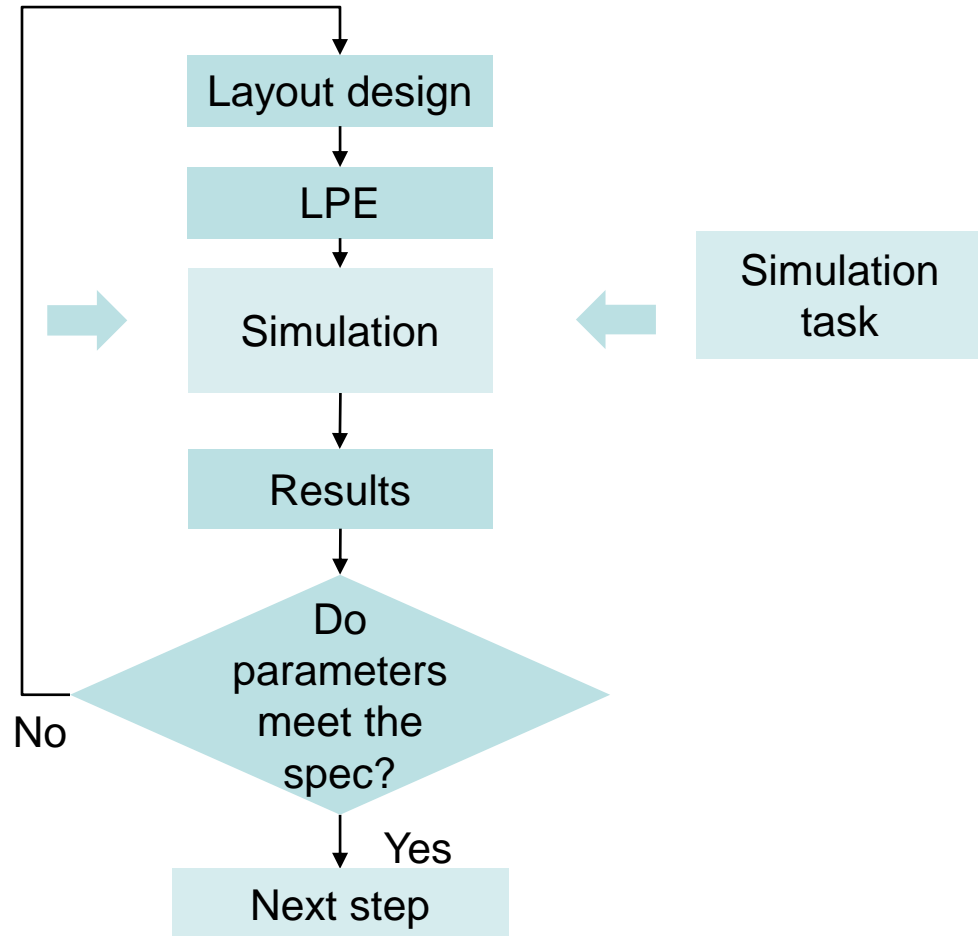
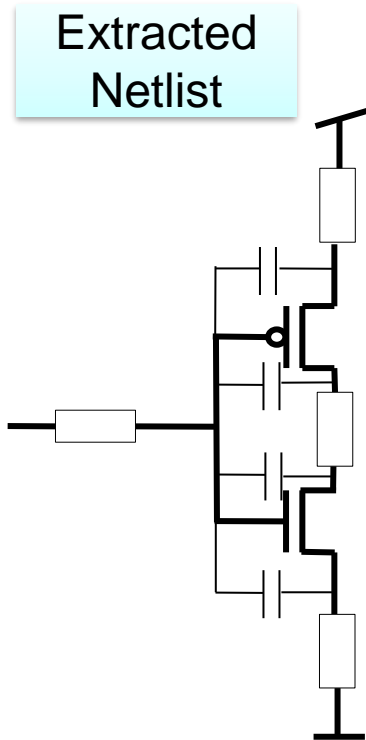
# Layout Parasitic Extraction (LPE)

- There is a parasitic extractor tool which calculates parasitic devices present in layout adds them back to circuit



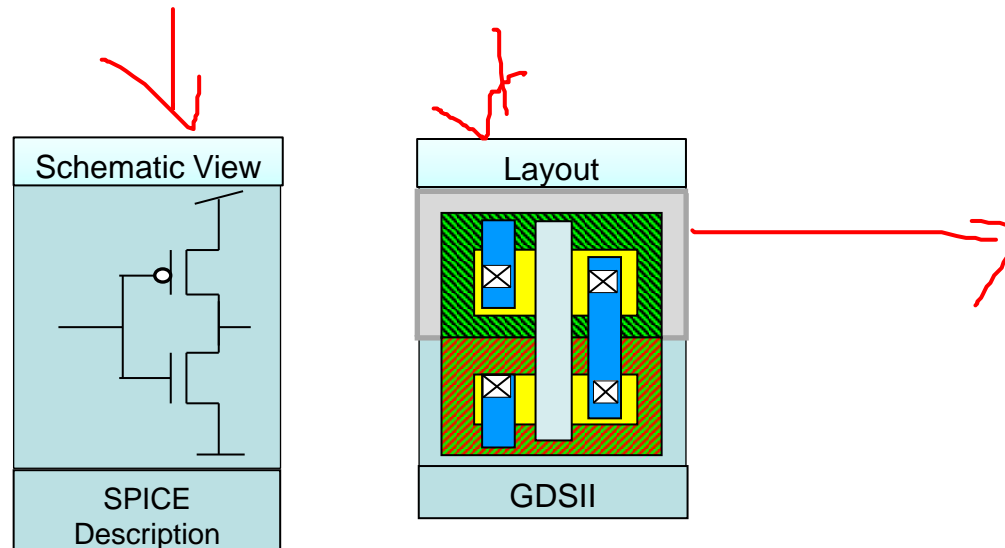


# Simulation of Extracted Netlist



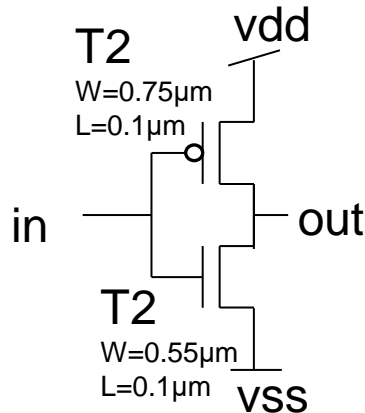
# Deliverables

- Completed design is a set of files which represent different design views:
  - SPICE netlist format is used to deliver schematic view
  - GDSII binary format is used to deliver layout of the circuit



# SPICE Description Example

- SPICE is a hardware description language (HDL) which enables to describe circuit at device level
- It has text-based format so is readable and can be easily modified

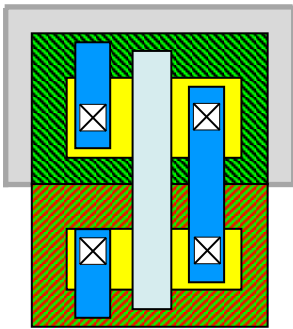


## Inverter.sp

```
.subckt inverter
    mt1 out in vdd nmos l = 0.1u w = 0.75u
    mt2 out in vdd pmos l = 0.1u w = 0.55u
.ends
```

# An Example of GDSII File

- GDSII is binary format, therefore it is not readable



## Inverter.gds

```
02000200 60000201 1C000300 02000600 .....` .... 000000
01000E00 02000200 60002500 01000E00 .....%.` ..... 000010
42494C45 4C504D41 58450602 12002500 .%....EXAMPLELIB 000020
413E0503 14000300 02220600 59524152 RARY..".....>A 000030
1C00545A 9BA02FB8 4439EFA7 C64B3789 .7K...9D./..ZT.. 00004
60000000 01000E00 02000200 60000205 ...` .....` 000050
58450606 0C001100 01000E00 02000200 .....EX 000060
0100020D 06000008 04000045 4C504D41 AMPLE..... 000070
0000F0D8 FFFF0310 2C000000 020E0600 ..... ,..... 000080
FFFF204E 00001027 0000204E 00001027 '...N ..'...N .. 000090
0000F0D8 FFFF0D8 FFFF0D8 FFFF0D8 ..... 0000A0
00000004 04000007 04000011 04001027 '..... 0000B0
00000000 00000000 00000000 00000000 ..... 0000C0
```

- Here you can see the video for the last semester :

[https://drive.google.com/drive/folders/1K93besY9AgrdZINq\\_c\\_bJpYxee\\_Clc17?fbclid=IwAR1MqeygRwDNeaRO6qVidAMxVs16s\\_jDGKZCdi4UvsEDaYzSAS0vgfLLT00](https://drive.google.com/drive/folders/1K93besY9AgrdZINq_c_bJpYxee_Clc17?fbclid=IwAR1MqeygRwDNeaRO6qVidAMxVs16s_jDGKZCdi4UvsEDaYzSAS0vgfLLT00)

# Micro wind tool

Please find the session video and the NAND gate video in the following playlist:  
[https://www.youtube.com/playlist?list=PLnyw1IVZpaTvffKO\\_v6z3TmVYxZEsiTU-](https://www.youtube.com/playlist?list=PLnyw1IVZpaTvffKO_v6z3TmVYxZEsiTU-)

Session :

[https://www.youtube.com/playlist?list=PLnyw1IVZpaTvffKO\\_v6z3TmVYxZEsiTU-&fbclid=IwAR2aURctuJ3Hdwltm2ORqST37kL86wQibK-ZZxVZmBxNDWZ-bLP4etO6cBE](https://www.youtube.com/playlist?list=PLnyw1IVZpaTvffKO_v6z3TmVYxZEsiTU-&fbclid=IwAR2aURctuJ3Hdwltm2ORqST37kL86wQibK-ZZxVZmBxNDWZ-bLP4etO6cBE)

an example for designing nand gate using microwind.

<http://bit.ly/34jITzX>